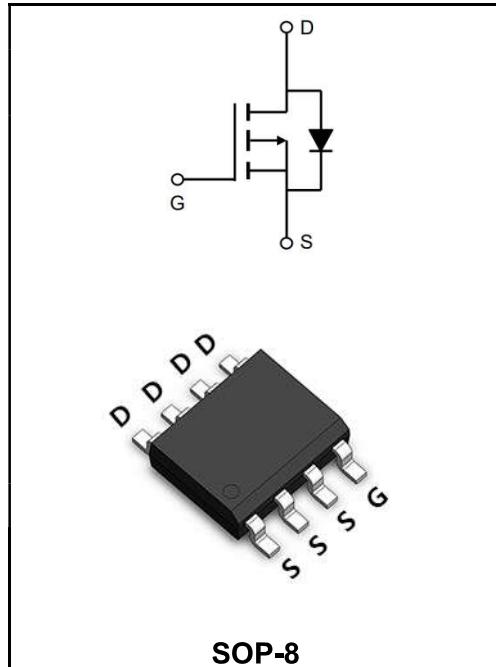


-40V P-CHANNEL ENHANCEMENT MODE MOSFET
MAIN CHARACTERISTICS

I_D	-12A
V_{DSS}	-40V
$R_{DS(on)-typ}(@V_{GS}=-10V)$	< 18mΩ(Type:14 mΩ)


Application

- ◆ Battery protection
- ◆ Load switch
- ◆ Uninterruptible power supply

Maximum Ratings at $T_c=25^\circ\text{C}$ unless otherwise specified

Characteristics	Symbols	Value	Units
Drain-Source Voltage	V_{DS}	-40	V
Gate - Source Voltage	V_{GS}	± 20	V
Continuous Drain Current, $V_{GS} @ -10V^1$ @ $T_c=25^\circ\text{C}$	I_D	-12	A
Continuous Drain Current, $V_{GS} @ -10V^1$ @ $T_c=75^\circ\text{C}$	I_D	-8.9	A
Pulsed Drain Current ²	I_{DM}	-36	A
Single Pulse Avalanche Energy ³	E_{AS}	125	mJ
Total Power Dissipation ⁴ @ $T_c=25^\circ\text{C}$	P_D	3.5	W
Total Power Dissipation ⁴ @ $T_A=25^\circ\text{C}$	P_D	1.9	W
Storage Temperature Range	T_{STG}	-55 to +150	°C
Operating Junction Temperature Range	T_J	-55 to +150	°C
Thermal Resistance Junction-Ambient ¹	$R_{θJA}$	85	°C/W
Thermal Resistance Junction to Case ¹	$R_{θJC}$	5	°C/W

Maximum Ratings at T_c=25°C unless otherwise specified

Characteristics	Test Condition	Symbols	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250uA	BV _{DSS}	-40	-44	-	V
BVDSS Temperature Coefficient	Reference to 25°C , I _D =-1mA	ΔBV _{DSS/ΔTJ}	-	-0.023	-	V/°C
Static Drain-Source On-Resistance ²	V _{GS} =-10V, I _D =-30A	R _{DS(ON)}	-	14	18	mΩ
	V _{GS} =-4.5V, I _D =-20A		-	18	25	
Gate -Threshold Voltage	V _{DS} =V _{GS} , I _D =-250uA	V _{GS(th)}	-1.0	-1.6	-2.5	V
V _{GS(th)} Temperature Coefficient		ΔV _{GS(th)}	-	4.74	-	mV/°C
Drain-Source Leakage Current	V _{DS} =-40V , V _{GS} =0V , T _J =25°C	I _{DSS}	-	-	1	μA
	V _{DS} =-40V , V _{GS} =0V , T _J =55°C		-	-	5	
Gate –Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	I _{GSS}	-	-	±100	nA
Total Gate Charge(-4.5V)	V _{DS} =-20V V _{GS} =-4.5V I _D =12A	Q _g	-	25	-	nC
Gate-Source Charge		Q _{gs}	-	11	-	
Gate-Drain Charge		Q _{gd}	-	9.5	-	
Turn-on delay time	V _{DD} =-15V R _L =15 Ω I _D =-1A VGEN=-10V R _G =6Ω	t _{d(on)}	-	48	-	ns
Rise Time		T _r	-	24	-	
Turn-Off Delay Time		t _{d(OFF)}	-	88	-	
Fall Time		t _f	-	9.6	-	
Input Capacitance	V _{DS} =-20V V _{GS} =0V f=1MHz	C _{iss}	-	2760	-	pF
Output Capacitance		C _{oss}	-	260	-	
Reverse Transfer Capacitance		C _{rss}	-	85	-	
Continuous Source Current ^{1,5}	V _G =V _D =0V , Force Current	I _s	-	-	-40	A
Pulsed Source Current ^{2,5}		I _{SM}	-	-	-90	A
Diode Forward Voltage ²	V _{GS} =0V , I _s =-1A , T _J =25°C	V _{SD}	-	-	-1.3	V

Note :

- 1、The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2、The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
- 3、The power dissipation is limited by 150°C junction temperature
- 4、The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Ratings and Characteristic Curves

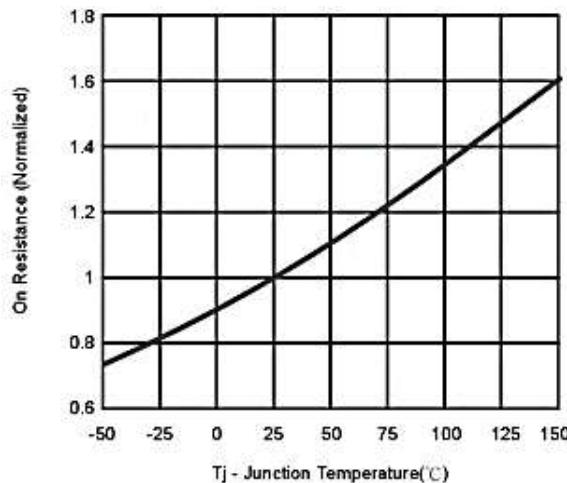


Fig.1 On Resistance Vs Junction Temperature

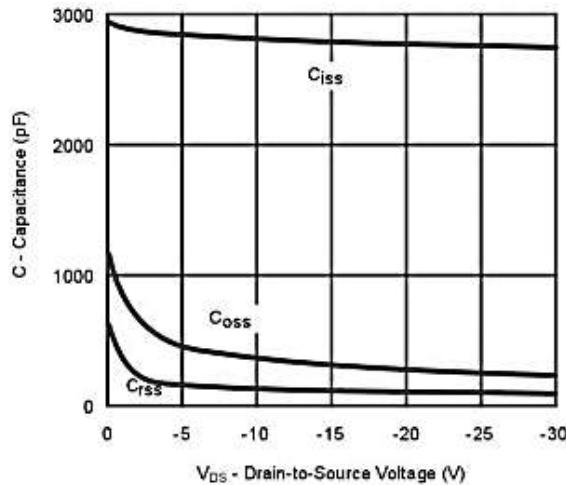


Fig.3 Capacitance

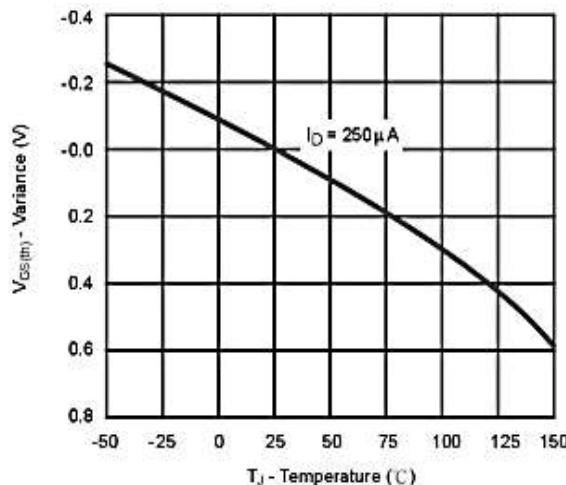


Fig.5 Threshold Voltage

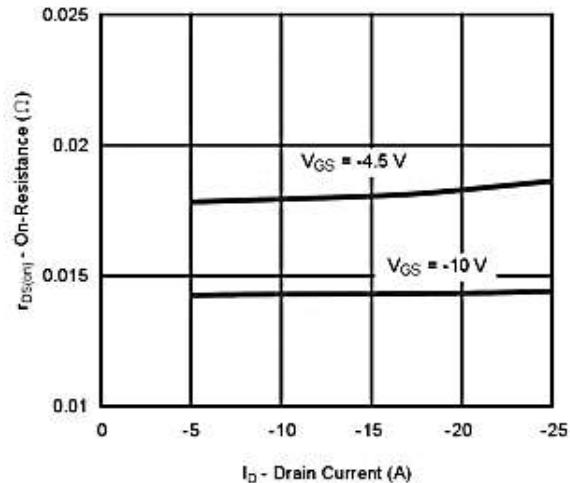


Fig.2 On-Resistance Vs.Drain Current

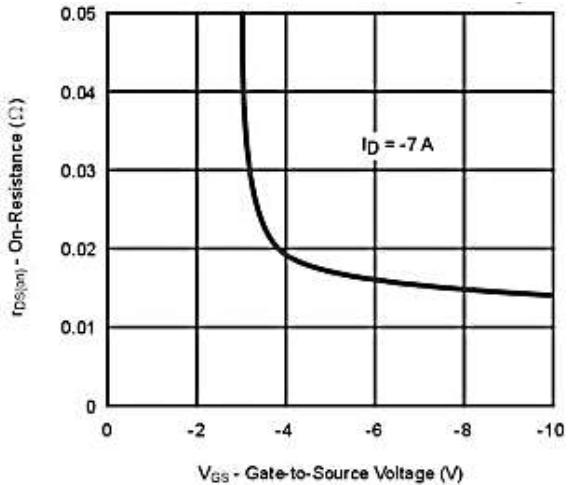


Fig.4 On-Resistance Vs. Gate-to-Sourece Voltage

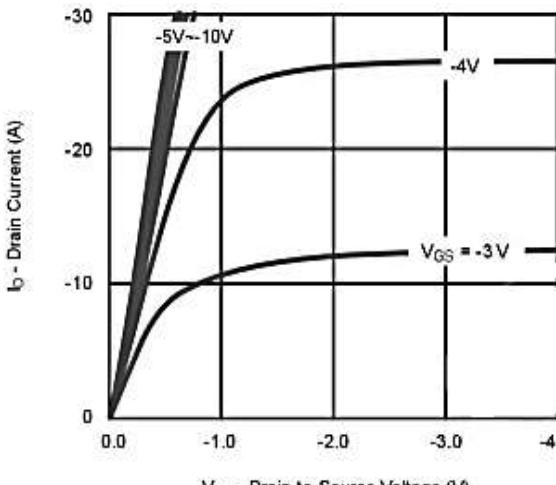


Fig.6 On-Region Characteristics

Ratings and Characteristic Curves

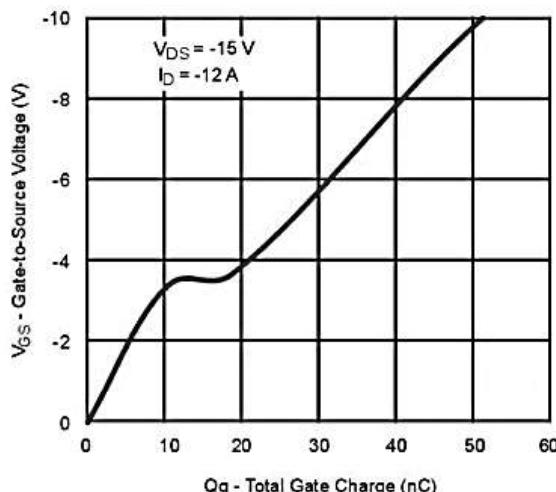


Fig.7 Gate Charge

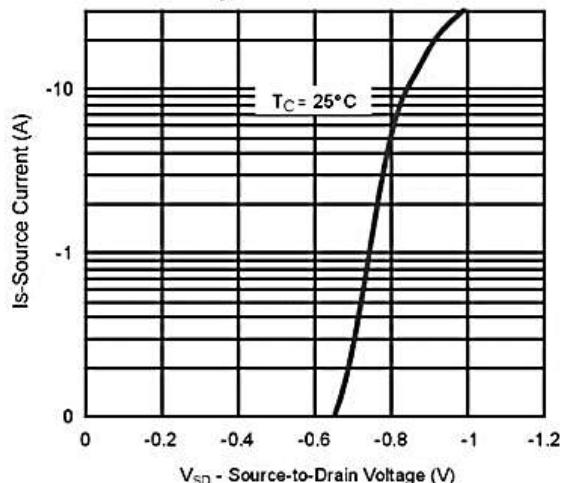


Fig.8 Body-diode Characteristic

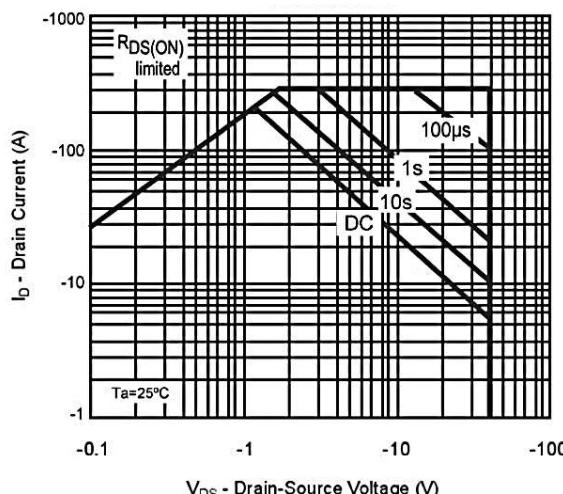


Fig.9 Safe Operating Area

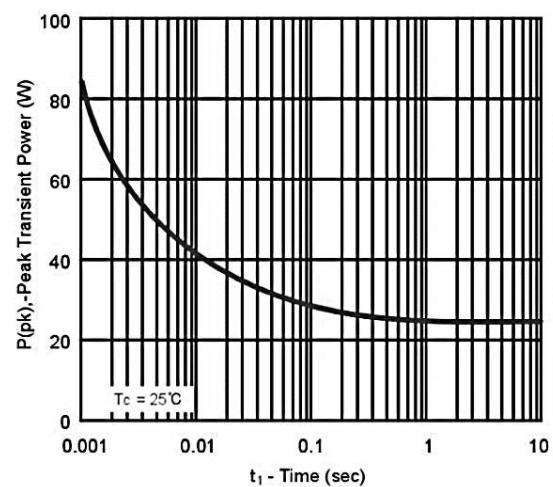


Fig.10 Single Pulse Maximum Power Dissipation

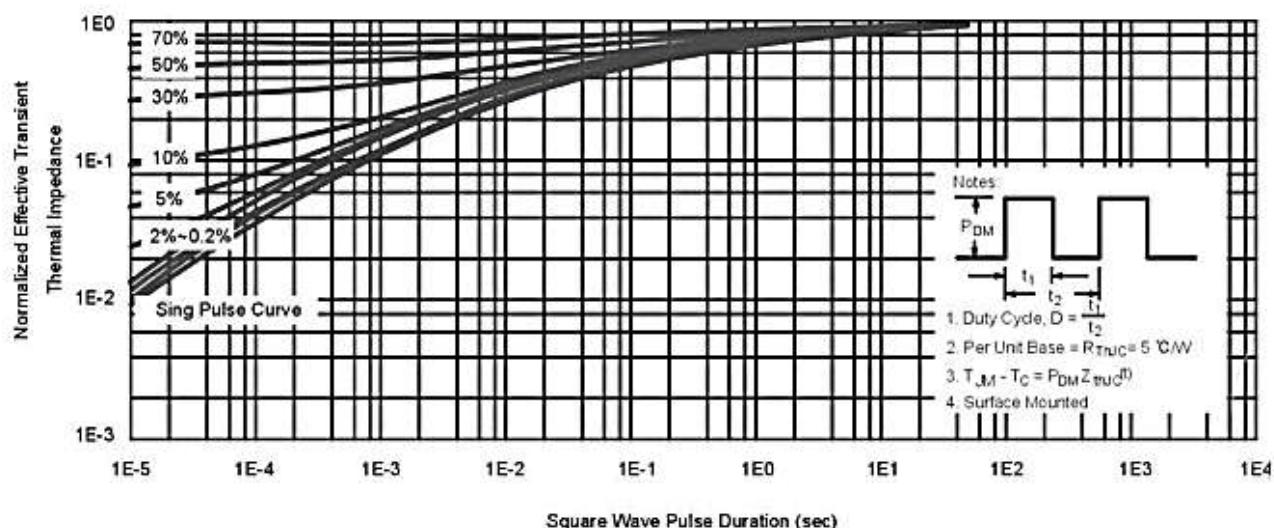
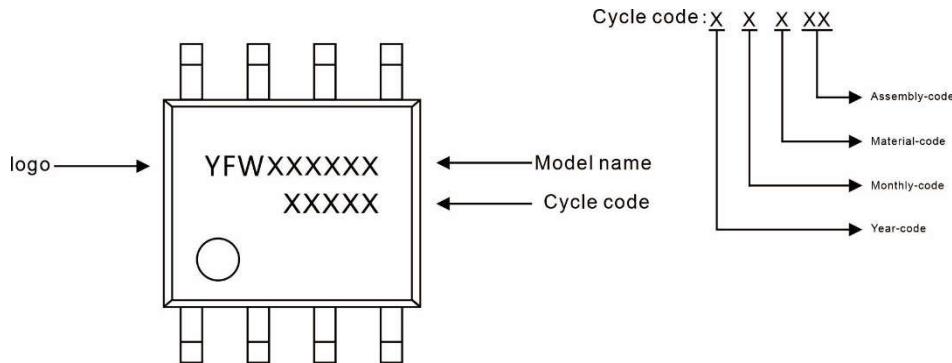


Fig.11 Normalized Maximum Transient Thermal Impedance

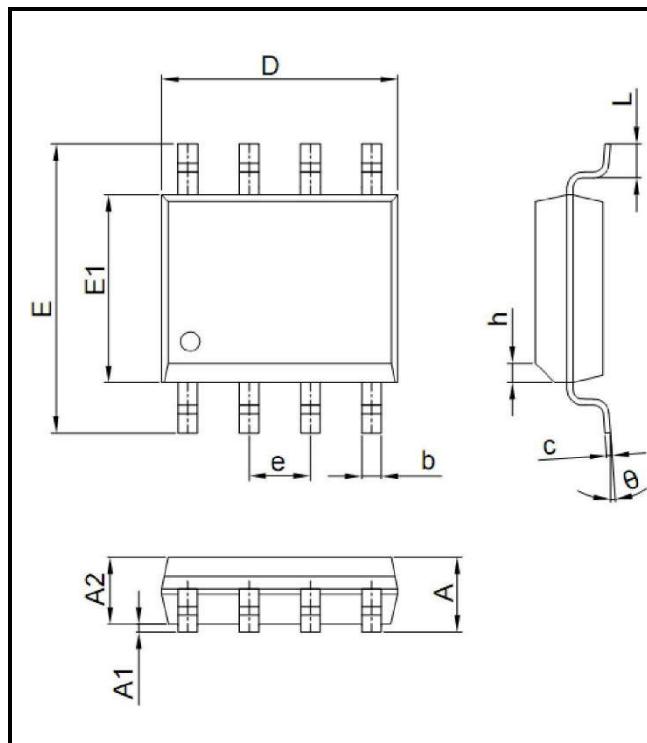
Marking Diagram



Ordering information

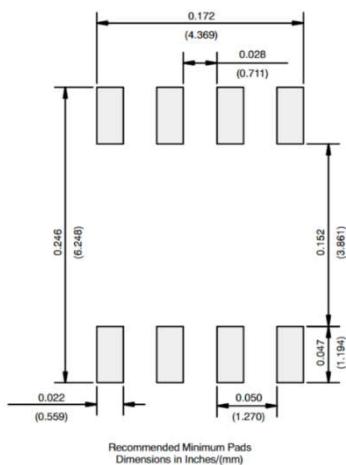
Package	Packing Description	Packing Quantity
SOP-8	Tape/Reel,13"reel	3000PCS/Reel 30000PCS/Carton

Package Dimensions

SOP-8


Dim	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	1.35	1.75	0.053	0.069
A1	0.10	0.25	0.004	0.010
A2	1.35	1.50	0.053	0.059
b	0.35	0.55	0.014	0.022
c	0.15	0.25	0.006	0.010
D	4.80	5.00	0.189	0.197
D1	3.10	3.50	0.122	0.138
E	5.80	6.20	0.228	0.244
E1	3.80	4.00	0.150	0.157
E2	2.20	2.60	0.087	0.102
e	1.27 (BSC)		0.050 (BSC)	
L	0.40	1.27	0.016	0.050
θ	0°	8°	0°	8°

The recommended mounting pad size



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